### SQJA16EP

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**Vishay Siliconix** 

### Automotive N-Channel 60 V (D-S) 175 °C MOSFET

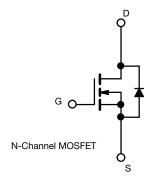


Top View	Top View Bottom View	
PRODUCT SUMMARY		
V <sub>DS</sub> (V)	60	
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0030	
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0047	
I <sub>D</sub> (A)	278	
Configuration	Single	
Package	PowerPAK SO-8L	

#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ABSOLUTE MAXIMUM RATING	<b>GS</b> (T <sub>C</sub> = 25 °C, unless	otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	60	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current	$T_{C} = 25 \ ^{\circ}C \ ^{a}$	1-	278		
Continuous drain current	T <sub>C</sub> = 125 °C	Ι <sub>D</sub>	166		
Continuous source current (diode conduction) <sup>a</sup>		I <sub>S</sub>	454	А	
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	575		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	48		
Single pulse avalanche energy		E <sub>AS</sub>	115	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C	D	500	W	
Maximum power dissipation	T <sub>C</sub> = 125 °C	PD	166	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak tempera	ature) <sup>d</sup>	-	260	C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	42	°C/W
Junction-to-case (drain)		R <sub>thJC</sub>	0.30	C/ W

#### Notes

- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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a. Package limited

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•	•		•	•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		60	-	-	v
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		1.5	2.0	2.5	v
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 175 °C	-	-	250	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	30	-	-	А
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = 10 V$	I <sub>D</sub> = 15 A	-	0.0026	0.0030	
	P	$V_{GS} = 10 V$	I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C	-	-	0.00516	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 15 A, T <sub>J</sub> = 175 °C	-	-	0.0065	
		$V_{GS} = 4.5 V$	I <sub>D</sub> = 15 A	-	0.0036	0.0047	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	-	75	-	S	
Dynamic <sup>b</sup>		<u>.</u>					
Input capacitance	C <sub>iss</sub>			-	3915	5485	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 25 V, f = 1 MHz	-	1780	2500	pF
Reverse transfer capacitance	C <sub>rss</sub>			-	65	95	
Total gate charge <sup>c</sup>	Qg			-	56	84	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 30 \text{ V}, I_{D} = 10 \text{ A}$	-	13	-	nC
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	5	-	
Gate resistance	Rg	f = 1 MHz		0.6	1.3	2.0	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>		$V_{DD} = 30 \text{ V}, \text{ R}_{L} = 3.0 \ \Omega$ $\text{I}_{D} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{g} = 1 \ \Omega$		13	20	- ns
Rise time <sup>c</sup>	tr	V <sub>DD</sub> =			4	6	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A},$			34	50	
Fall time <sup>c</sup>	t <sub>f</sub>			-	6	9	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>	•		•	•	•	
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	575	А
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 15 A, V <sub>GS</sub> = 0 V		-	-	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>			-	54	108	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 8 A, di/dt = 100 A/μs		-	64	128	nC
Reverse recovery fall time	t <sub>a</sub>			-	26	-	-
Reverse recovery rise time	t <sub>b</sub>		1		30	-	ns
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	2.0	-	А

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

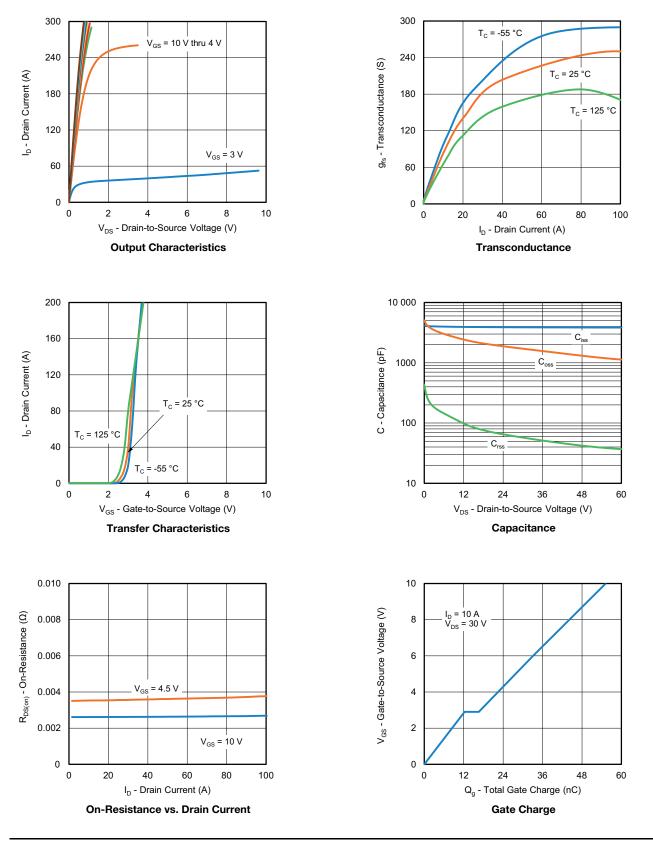
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



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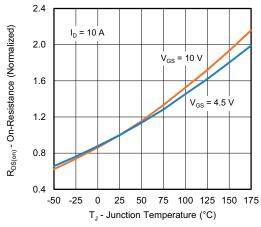
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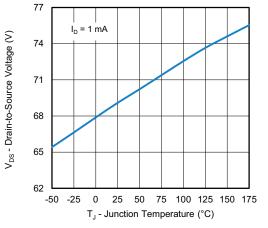
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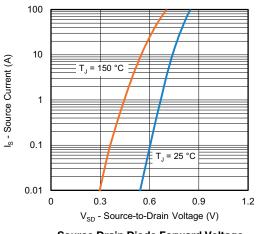
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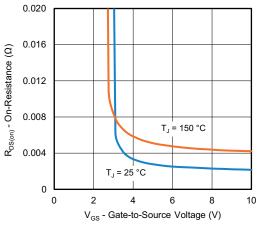
**On-Resistance vs. Junction Temperature** 



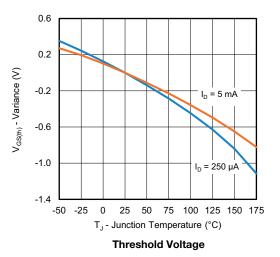
Drain Source Breakdown vs. Junction Temperature

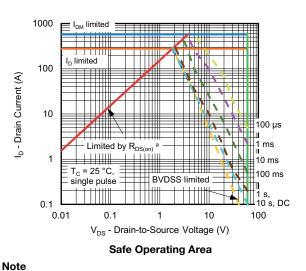


Source Drain Diode Forward Voltage



**On-Resistance vs. Gate-to Source Voltage** 





a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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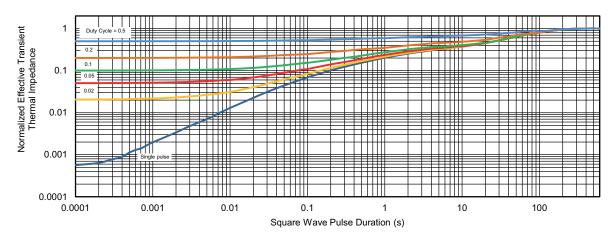
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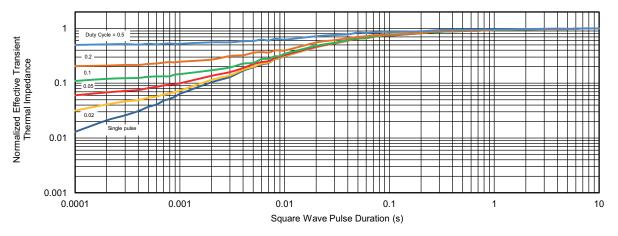
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#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

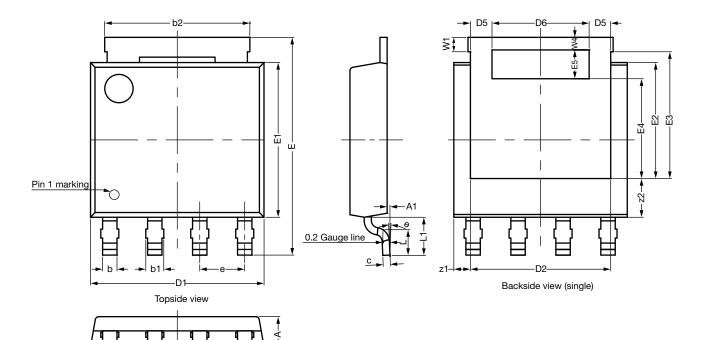


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76726.



# PowerPAK<sup>®</sup> SO-8L (PPKSO8LWLA) Case Outline 3



DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	1.00	1.05	1.10	0.039	0.041	0.043		
A1	0.00		0.127	0.000		0.005		
b	0.33	0.41	0.49	0.013	0.016	0.019		
b1	0.43	0.51	0.59	0.017	0.020	0.023		
b2	4.00	4.10	4.20	0.157	0.161	0.165		
С	0.15	0.20	0.25	0.006	0.008	0.010		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D5	0.51	0.61	0.71	0.020	0.024	0.028		
D6	2.64	2.74	2.84	0.104	0.108	0.112		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	3.18	3.28	3.38	0.125	0.129	0.133		
E3	3.48	3.58	3.68	0.137	0.141	0.145		
E4	2.72	2.82	2.92	0.107	0.111	0.115		
E5	0.71	0.81	0.91	0.028	0.032	0.036		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
W1	0.31	0.41	0.51	0.012	0.016	0.020		
W4	0.31	0.36	0.41	0.012	0.014	0.016		
z1	0.37	0.47	0.57	0.015	0.019	0.022		
z2	0.99	1.09	1.19	0.039	0.043	0.047		
θ	0°		5°	0°		5°		

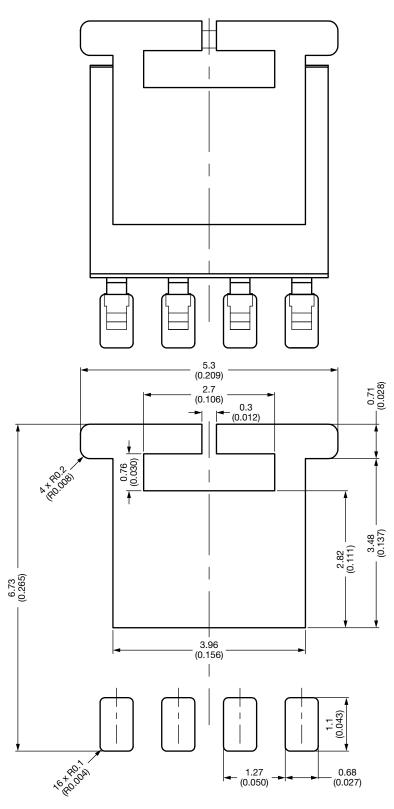
Note

• Millimeter will govern

1



## **Recommended Land Pattern PowerPAK® SO-8L Single Short Ear**



Dimensions in Millimeters (Inches)

Revision: 24-Aug-2021

Document Number: 78020



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